LVB-8370-PI



AI Powered MTK 8370 ARM System Board



Features:

- Purpose built for 7"-15.6"panel PC
- Supports MT 8370, one system with high and low computing options
- 2.8 TOPS Al engine
- Type-C interface, widely adapts to IO design requirements
- Hardware monitoring adapting cloud management

Specification

Computing System	
Operating System	Android 13 / Ubuntu 22.04 LTS / Yocto
CPU	MediaTek MT8370 Hexa-core CPU
	 Dual-core super cores:ARM Cortex-A78
	 Quad-core efficiency cores: ARM Cortex-A55
	Embedded powerful multi-core AI processors for edge AI
	applications
	 Up to 2.8 TOPS
	 Deep Learning Accelerator (DLA) + VP6
	NeuroPilot SDK
	 INT8, INT16 + FP16 capable
GPU	Integrated Mali-G57 GPU
	 Video decoding up to 4K 75fps
	 Dual decoding up to one 4K and one 2K
	 Video encoding up to 4K 30fps with HEVC
	 Support AV I/H.265/H.264 CODEC
	 Support OpenGL/CL/Vulkan
Memory	On-board 4GB LPDDR4X system memory (Up to 8GB)
Storage	On-board 32GB eMMC storage (Up to 64GB)
Storage Slot	MicroSD 3.0 (SDXC) slot x1
PMIC	MediaTek MT6365 PMIC
RTC	Built-in Real Time Clock (RTC)

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I/Os	
M.2 Socket	M.2 socket, Key E x I
	 Supports Wi-Fi/Bluetooth module (optional)
	 Supports M.2 Wireless/Cellular module (optional)
Display Interface	MIPI DSI:
	■ Supported Sizes: 5.5", 7", 8", 10.1"
	■ Resolution: I280x800 & I280x720
	eDP:
	■ Supported Size: I 5.6"
	Resolution: 1920×1080
	■ Remark: Project Based
отб	Micro USB x I
Connectors	8-pin Wafer Connector for (12V@2A) Power Input x1
	10-pin Wafer Connector for I2C & Control pin connection x1
	50-pin Coaxial Cable Connector for MIPI/HDMI/USB interface connection $\times I$
Environmental	
Operating Temperature Range	0°C ~ 60°C
Operating Humidity Range	20% ~ 80% RH non-condensing
Storage Temperature Range	-40°C ~ 85°C
Storage Humidity Range	20% ~ 80% RH non-condensing
Dimensions	
Dimensions	155 x 79 x 12 mm